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The SN5405 is obsolete
and no longer is supplied.

SN54LS05, SN54S05 SN7405, SN74LS05, SN74S05

HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS

SDLS030A – DECEMBER 1983 – REVISED NOVEMBER 2003

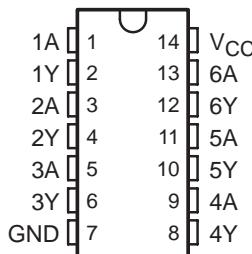
- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

SN5405, SN54LS05, SN54S05 . . . J PACKAGE

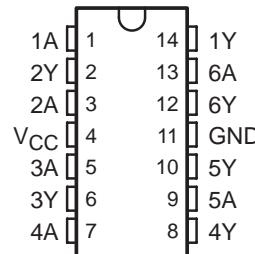
SN7405 . . . N PACKAGE

SN74LS05 . . . D, DB, N, OR NS PACKAGE

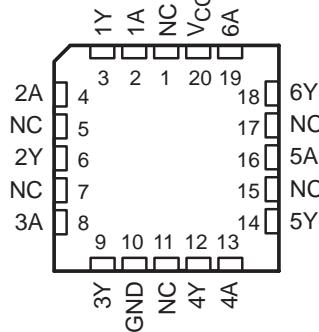
**SN74S05 . . . D, N, OR NS PACKAGE
(TOP VIEW)**



**SN54LS05, SN54S05 . . . W PACKAGE
(TOP VIEW)**



**SN54LS05, SN54S05 . . . FK PACKAGE
(TOP VIEW)**



NC – No internal connection

description/ordering information

These devices contain six independent inverters. To perform correctly, the open-collector outputs require pullup resistors. These devices may be connected to other open-collector outputs to implement active-low wired-OR or active-high wire-AND functions. Open-collector devices often are used to generate high V_{OH} levels.

ORDERING INFORMATION

| TA | PACKAGE [†] | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------------------|---------------|-----------------------|------------------|
| 0°C to 70°C | PDIP – N | Tube | SN7405N | SN7405N |
| | | | SN74LS05N | SN74LS05N |
| | | | SN74S05N | SN74S05N |
| | SOIC – D | Tube | SN74LS05D | LS05 |
| | | Tape and reel | SN74LS05DR | |
| | | Tube | SN74S05D | S05 |
| | | Tape and reel | SN74S05DR | |
| | SOP – NS | Tape and reel | SN74LS05NSR | 74LS05 |
| | | | SN74S05NSR | 74S05 |
| | SSOP – DB | Tape and reel | SN74LS05DBR | LS05 |
| -55°C to 125°C | CDIP – J | Tube | SNJ54LS05J | SNJ54LS05J |
| | | | SNJ54S05J | SNJ54S05J |
| | CDIP – W | Tube | SNJ54LS05W | SNJ54LS05W |
| | | | SNJ54S05W | SNJ54S05W |
| | LCCC – FK | Tube | SNJ54LS05FK | SNJ54LS05FK |
| | | | SNJ54S05FK | SNJ54S05FK |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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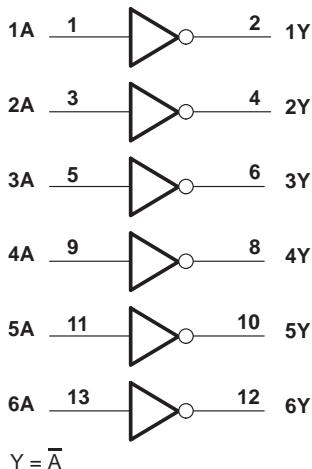
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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54LS05, SN54S05
SN7405, SN74LS05, SN74S05
HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS
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The SN5405 is obsolete
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FUNCTION TABLE
(each inverter)

| INPUT A | OUTPUT Y |
|------------|-------------|
| H | L |
| L | H |

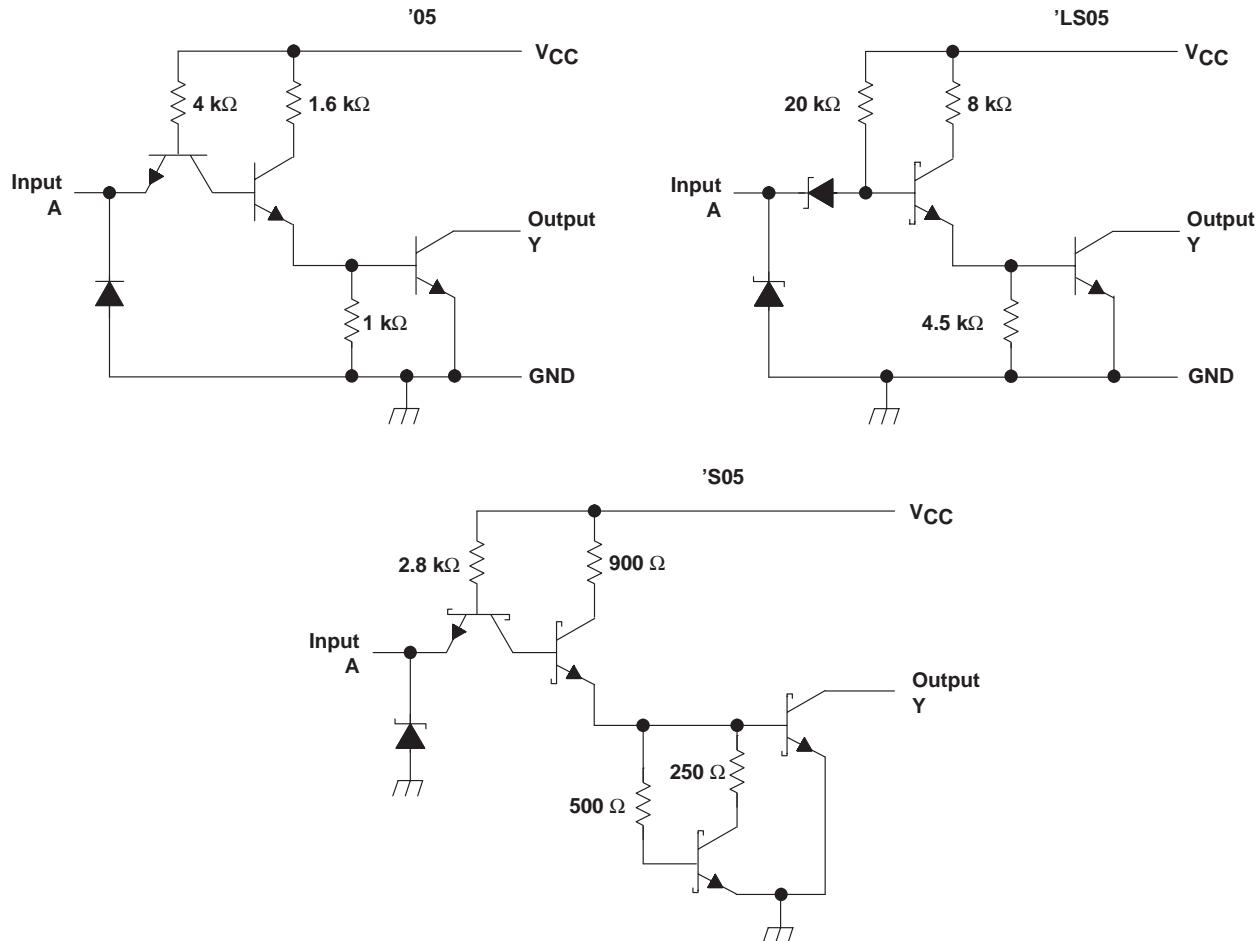
logic diagram (positive logic)

Pin numbers shown are for the D, DB, J, N, and NS packages.

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**SN54LS05, SN54S05
SN7405, SN74LS05, SN74S05
HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS**
SDLS030A – DECEMBER 1983 – REVISED NOVEMBER 2003

schematic (each inverter)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

| | |
|--|----------------|
| Supply voltage, V_{CC} (see Note 1): '05, 'LS05, 'S05 | 7 V |
| Input voltage, V_I : '05, 'S05 'LS05 | 5.5 V |
| Off-state output voltage, V_O | 7 V |
| Package thermal impedance, θ_{JA} (see Note 2): D package | 86°C/W |
| DB package | 96°C/W |
| N package | 80°C/W |
| NS package | 76°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

SN54LS05, SN54S05

SN7405, SN74LS05, SN74S05

HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS

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recommended operating conditions

| | | SN5405 | | | SN7405 | | | UNIT |
|-----------------|--------------------------------|--------|-----|-----|--------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} | High-level input voltage | | 2 | | | 2 | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} | High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} | Low-level output current | | | 16 | | | 16 | mA |
| T _A | Operating free-air temperature | -55 | 125 | 0 | 0 | 70 | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | SN5405 | | | SN7405 | | | UNIT |
|------------------|---|-------------------------|------------------|------|--------|------------------|------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -12 mA | | | -1.5 | | | -1.5 | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 5.5 V | V _{IL} = 0.8 V | | | | | 0.25 | mA |
| | | V _{IL} = 0.7 V | | 0.25 | | | | |
| V _{OL} | V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 16 mA | 0.2 | 0.4 | | 0.2 | 0.4 | | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.4 V | | | 40 | | | 40 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.4 V | | | -1.6 | | | -1.6 | mA |
| I _{CCH} | V _{CC} = MAX, V _I = 0 V | 6 | 12 | | 6 | 12 | | mA |
| I _{CCL} | V _{CC} = MAX, V _I = 4.5 V | 18 | 33 | | 18 | 33 | | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|------------------|--------------|-------------|------------------------|------------------------|-----|-----|-----|------|
| t _{PLH} | A | Y | R _L = 4 kΩ | C _L = 15 pF | | 40 | 55 | ns |
| t _{PHL} | | | R _L = 400 Ω | | | 8 | 15 | |

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**SN54LS05, SN54S05
SN7405, SN74LS05, SN74S05**
HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS
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recommended operating conditions

| | | SN54LS05 | | | SN74LS05 | | | UNIT |
|-----------------|--------------------------------|----------|-----|-----|----------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| V _{OH} | High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} | Low-level output current | | | 4 | | | 8 | mA |
| T _A | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | SN54LS05 | | | SN74LS05 | | | UNIT | |
|-------------------|---|------------------------|------------------|------|----------|------------------|------|------|----|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.5 | | | -1.5 | V | |
| I _{OH} | V _{CC} = MIN, V _{IL} = MAX, V _{OH} = 5.5 V | | | 0.1 | | | 0.1 | mA | |
| V _{OL} | V _{CC} = MIN, V _{IH} = 2 V | I _{OL} = 4 mA | 0.25 | 0.4 | 0.25 | 0.4 | | V | |
| | | I _{OL} = 8 mA | | | 0.35 | 0.5 | | | |
| I _I | V _{CC} = MAX, V _I = 7 V | | | 0.1 | | | 0.1 | mA | |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 20 | | | 20 | μA | |
| I _{IL} | V _{CC} = MAX, V _I = 0.4 V | | | -0.4 | | | -0.4 | mA | |
| I _{ICCH} | V _{CC} = MAX, V _I = 0 V | | | 1.2 | 2.4 | | 1.2 | 2.4 | mA |
| I _{ICCL} | V _{CC} = MAX, V _I = 4.5 V | | | 3.6 | 6.6 | | 3.6 | 6.6 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|---|-----|-----|-----|------|
| t _{PLH} | A | Y | R _L = 2 kΩ, C _L = 15 pF | | 17 | 32 | ns |
| | | | | | 15 | 28 | |

SN54LS05, SN54S05

SN7405, SN74LS05, SN74S05

HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS

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recommended operating conditions

| | | SN54S05 | | | SN74S05 | | | UNIT |
|-----------------|--------------------------------|---------|-----|-----|---------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V _{IH} | High-level input voltage | | 2 | | | 2 | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| V _{OH} | High-level output voltage | | | 5.5 | | | 5.5 | V |
| I _{OL} | Low-level output current | | | 20 | | | 20 | mA |
| T _A | Operating free-air temperature | -55 | 125 | 0 | 0 | 70 | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | SN54S05 | | | SN74S05 | | | UNIT |
|------------------|---|-------------------------|------------------|------|---------|------------------|------|------|
| | | MIN | TYP [‡] | MAX | MIN | TYP [‡] | MAX | |
| V _{IK} | V _{CC} = MIN, I _I = -18 mA | | | -1.2 | | | -1.2 | V |
| I _{OH} | V _{CC} = MIN, V _{OH} = 5.5 V | V _{IL} = 0.8 V | | | | | 0.25 | mA |
| | | V _{IL} = 0.7 V | | 0.25 | | | | |
| V _{OL} | V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 20 mA | | | 0.5 | | | 0.5 | V |
| I _I | V _{CC} = MAX, V _I = 5.5 V | | | 1 | | | 1 | mA |
| I _{IH} | V _{CC} = MAX, V _I = 2.7 V | | | 50 | | | 50 | μA |
| I _{IL} | V _{CC} = MAX, V _I = 0.5 V | | | -2 | | | -2 | mA |
| I _{CCH} | V _{CC} = MAX, V _I = 0 V | | 9 | 19.8 | | 9 | 19.8 | mA |
| I _{CCL} | V _{CC} = MAX, V _I = 4.5 V | | 30 | 54 | | 30 | 54 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

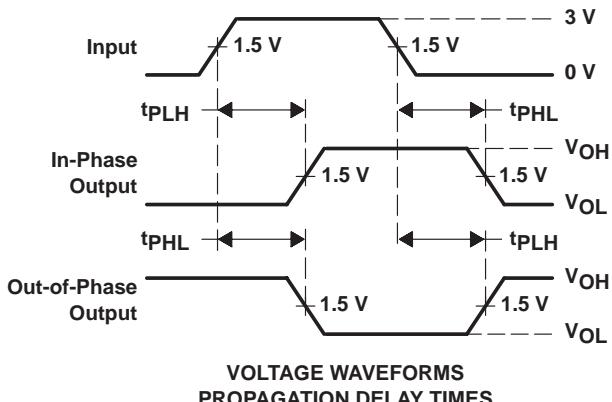
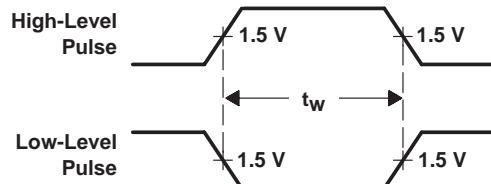
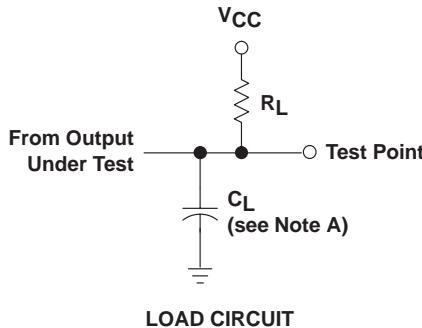
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|------------------|--------------|-------------|------------------------|------------------------|-----|-----|-----|------|
| t _{PLH} | A | Y | R _L = 280 Ω | C _L = 15 pF | 2 | 5 | 7.5 | ns |
| t _{PHL} | | | | C _L = 50 pF | 2 | 4.5 | 7 | |
| t _{PLH} | | | R _L = 280 Ω | C _L = 15 pF | | 7.5 | | ns |
| t _{PHL} | | | | C _L = 50 pF | | 7 | | |

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SN7405, SN74LS05, SN74S05**
HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS
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**PARAMETER MEASUREMENT INFORMATION
SERIES 54/74 AND 54S/74S DEVICES**



NOTES:

- C_L includes probe and jig capacitance.
- In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.
- All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O = 50 \Omega$, and:
 - For Series 54/74, $t_r \leq 7$ ns, $t_f \leq 7$ ns.
 - For Series 54S/74S, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
- The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

SN54LS05, SN54S05

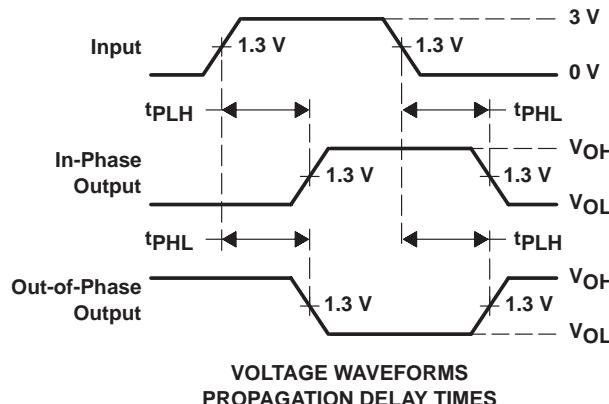
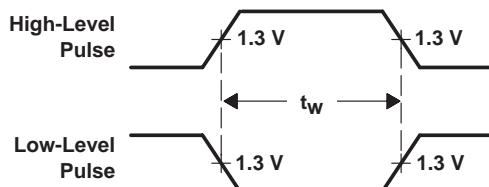
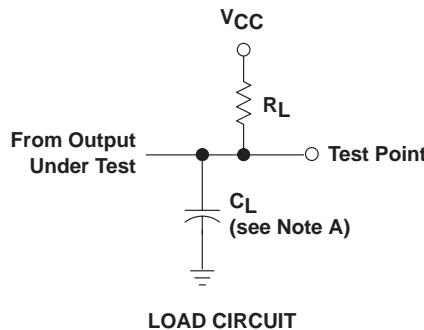
SN7405, SN74LS05, SN74S05

HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS

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PARAMETER MEASUREMENT INFORMATION
SERIES 54LS/74LS DEVICES



NOTES:

- C_L includes probe and jig capacitance.
- In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.
- All input pulses are supplied by generators having the following characteristics: $PRR \leq 1$ MHz, $Z_O = 50 \Omega$, $t_r \leq 1.5$ ns, $t_f \leq 2.6$ ns.
- The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| JM38510/07004BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | JM38510/ 07004BCA | Samples |
| M38510/07004BCA | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | JM38510/ 07004BCA | Samples |
| SN54LS05J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SN54LS05J | Samples |
| SN54S05J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SN54S05J | Samples |
| SN7405D | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN7405DR | OBSOLETE | SOIC | D | 14 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN7405N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN7405N | Samples |
| SN7405N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN7405NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN7405N | Samples |
| SN74LS05D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS05 | Samples |
| SN74LS05DBLE | OBSOLETE | SSOP | DB | 14 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN74LS05DBR | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS05 | Samples |
| SN74LS05DG4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS05 | Samples |
| SN74LS05DR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS05 | Samples |
| SN74LS05DRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS05 | Samples |
| SN74LS05N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS05N | Samples |
| SN74LS05N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN74LS05NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74LS05N | Samples |
| SN74LS05NSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS05 | Samples |

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74S05D | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | S05 | Samples |
| SN74S05N | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74S05N | Samples |
| SN74S05N3 | OBSOLETE | PDIP | N | 14 | | TBD | Call TI | Call TI | 0 to 70 | | |
| SN74S05NE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | SN74S05N | Samples |
| SN74S05NSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74S05 | Samples |
| SNJ54LS05FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | SNJ54LS05FK | Samples |
| SNJ54LS05J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SNJ54LS05J | Samples |
| SNJ54LS05W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SNJ54LS05W | Samples |
| SNJ54S05FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | SNJ54S05FK | Samples |
| SNJ54S05J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SNJ54S05J | Samples |
| SNJ54S05W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N / A for Pkg Type | -55 to 125 | SNJ54S05W | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS05, SN54S05, SN7405, SN74LS05, SN74S05 :

• Catalog: [SN74LS05](#), [SN74S05](#)

• Military: [SN5405](#), [SN54LS05](#), [SN54S05](#)

NOTE: Qualified Version Definitions:

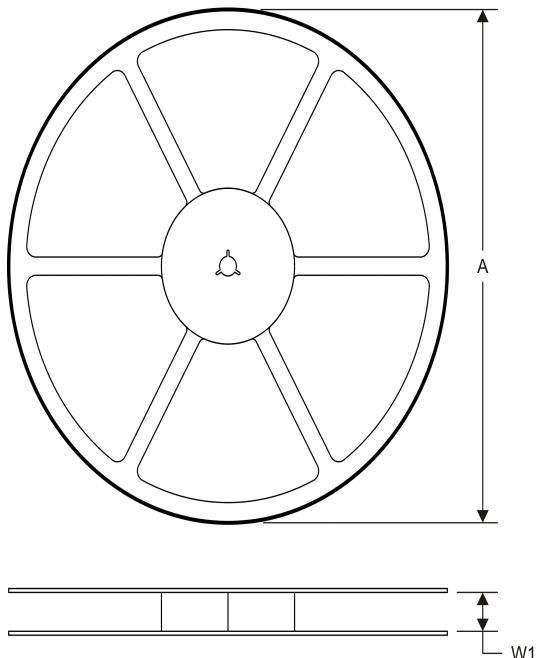
• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

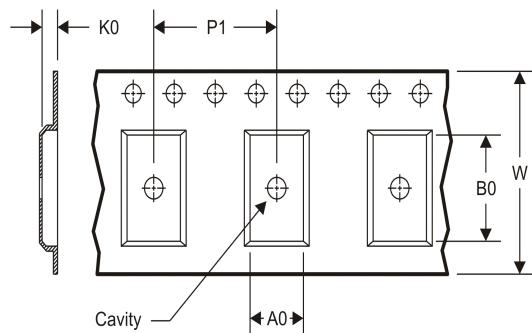
PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



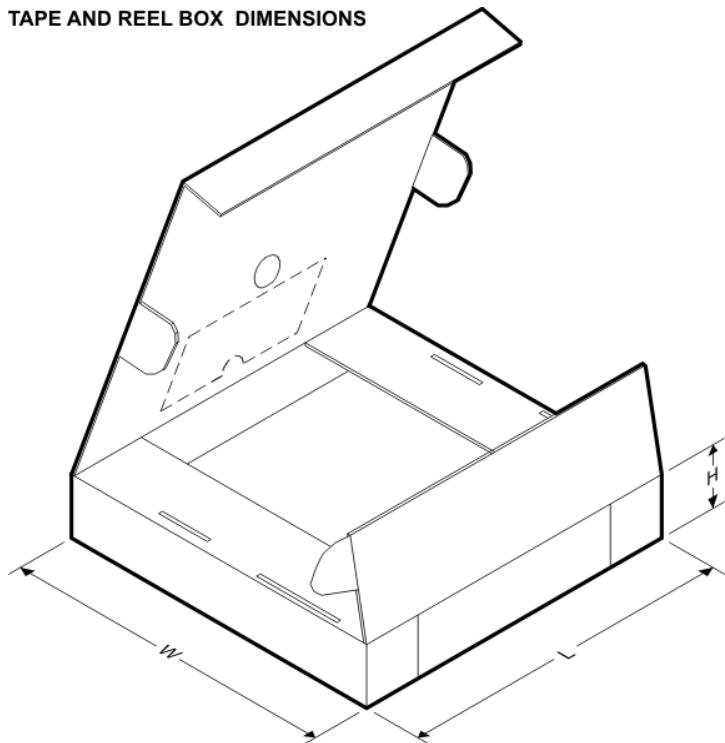
| | |
|----|---|
| A0 | Dimension designed to accommodate the component width |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LS05DBR | SSOP | DB | 14 | 2000 | 330.0 | 16.4 | 8.2 | 6.6 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LS05DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS05NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74S05NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



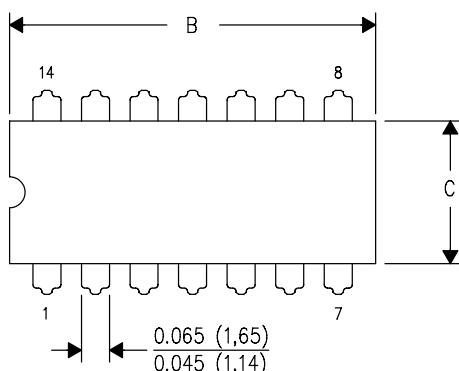
*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS05DBR | SSOP | DB | 14 | 2000 | 367.0 | 367.0 | 38.0 |
| SN74LS05DR | SOIC | D | 14 | 2500 | 367.0 | 367.0 | 38.0 |
| SN74LS05NSR | SO | NS | 14 | 2000 | 367.0 | 367.0 | 38.0 |
| SN74S05NSR | SO | NS | 14 | 2000 | 367.0 | 367.0 | 38.0 |

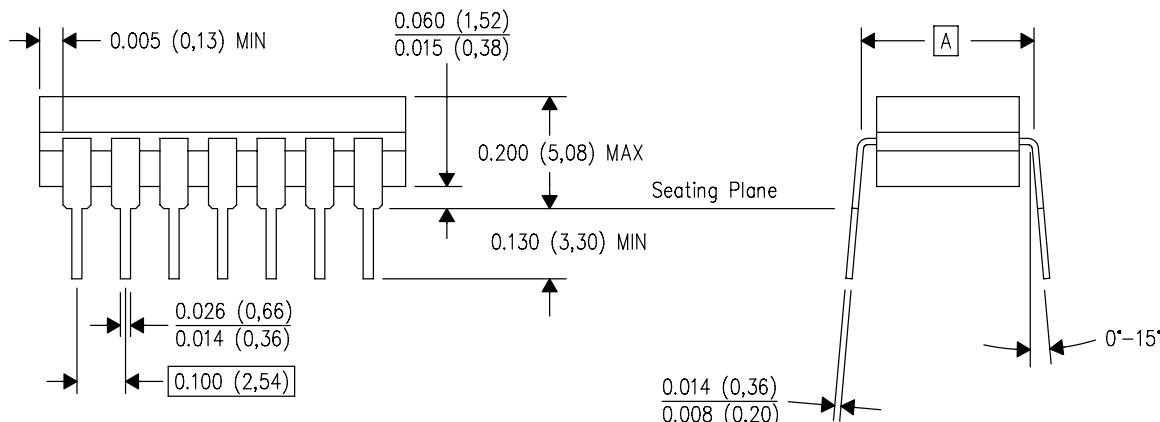
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM | PINS ** | 14 | 16 | 18 | 20 |
|-------|------------------|------------------|------------------|------------------|------------------|
| | | 14 | 16 | 18 | 20 |
| A | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) | |
| B MIN | — | — | — | — | |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) | |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) | |



4040083/F 03/03

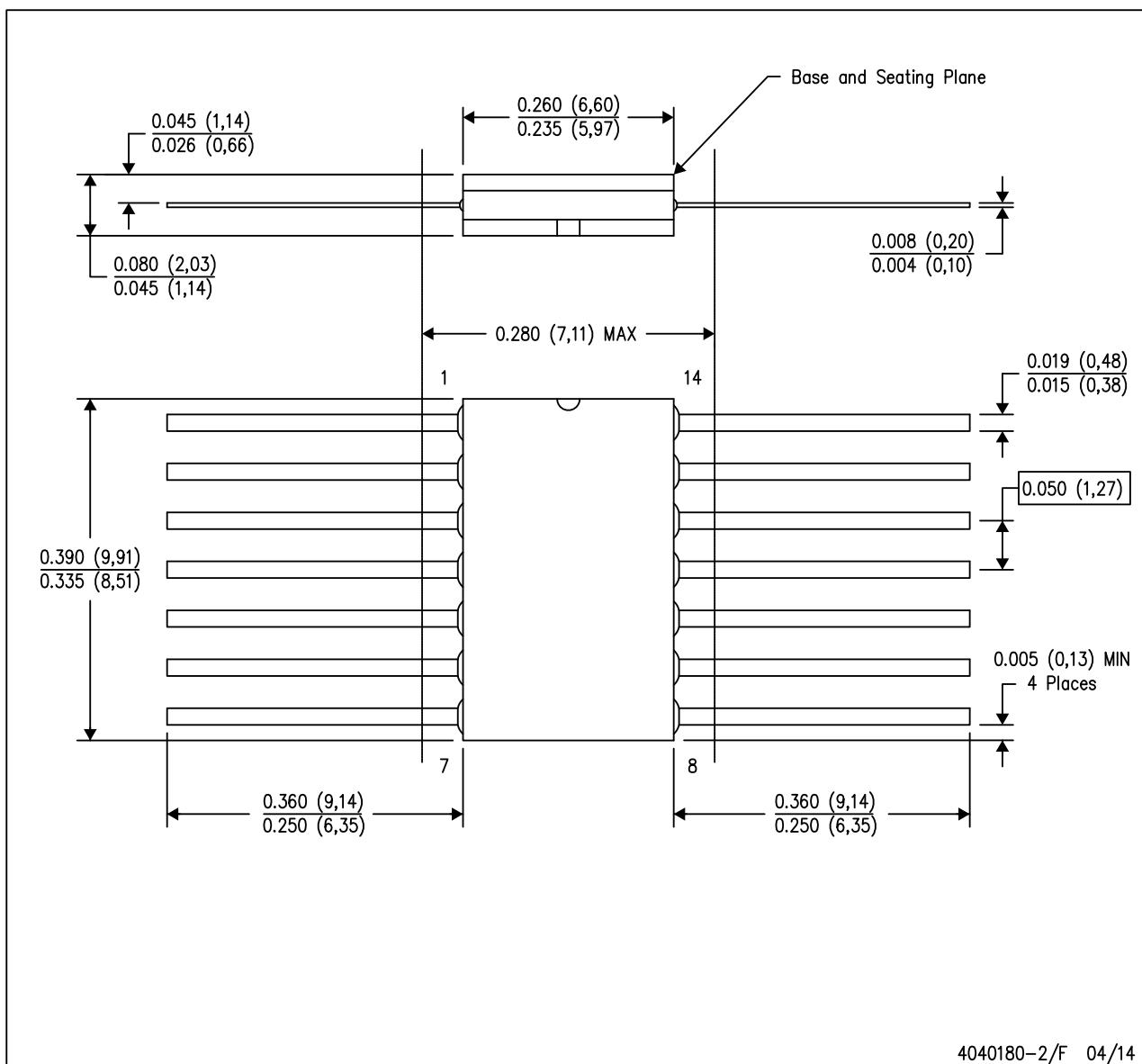
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MECHANICAL DATA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



4040180-2/F 04/14

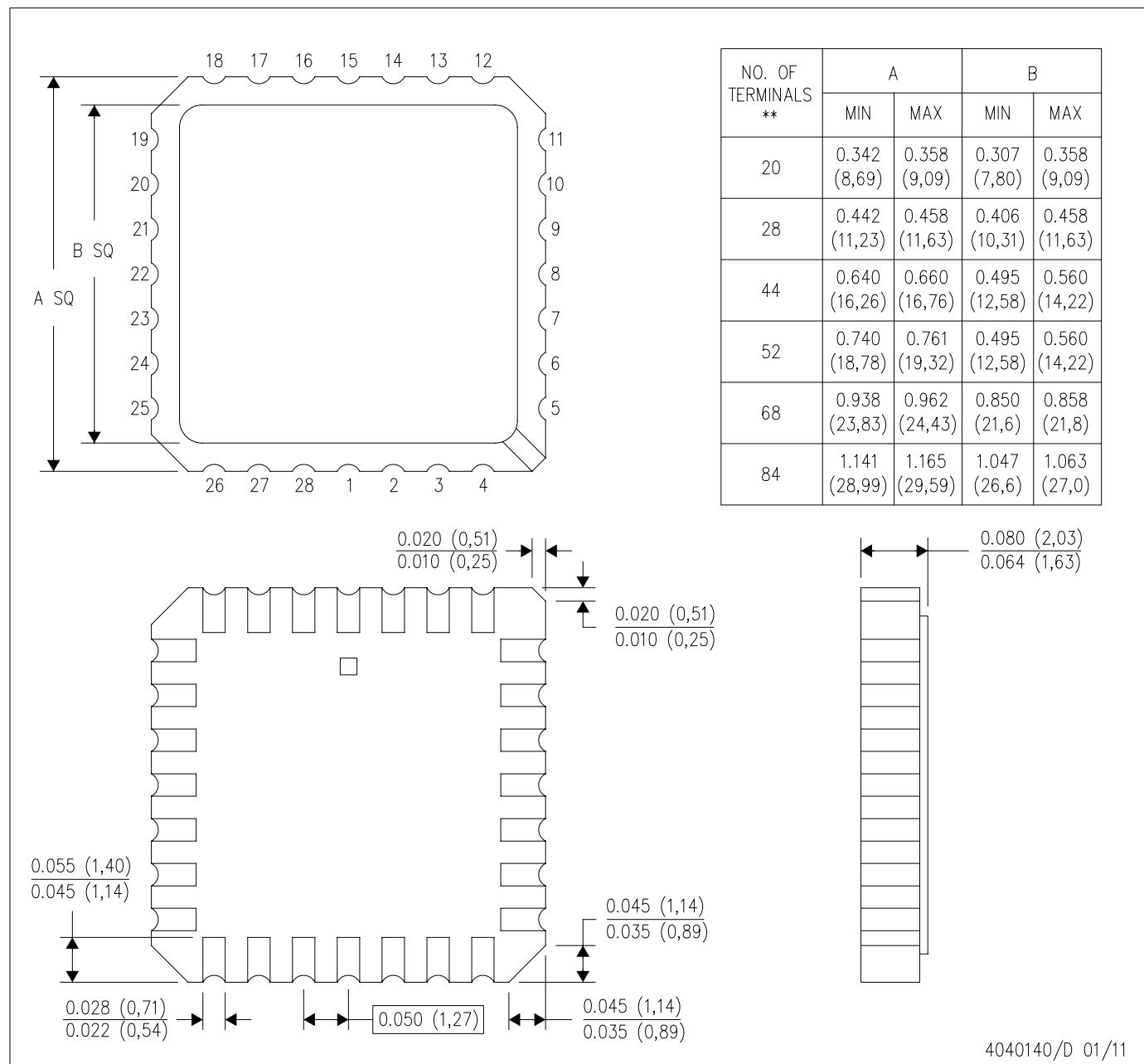
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a metal lid.
 D. Falls within JEDEC MS-004

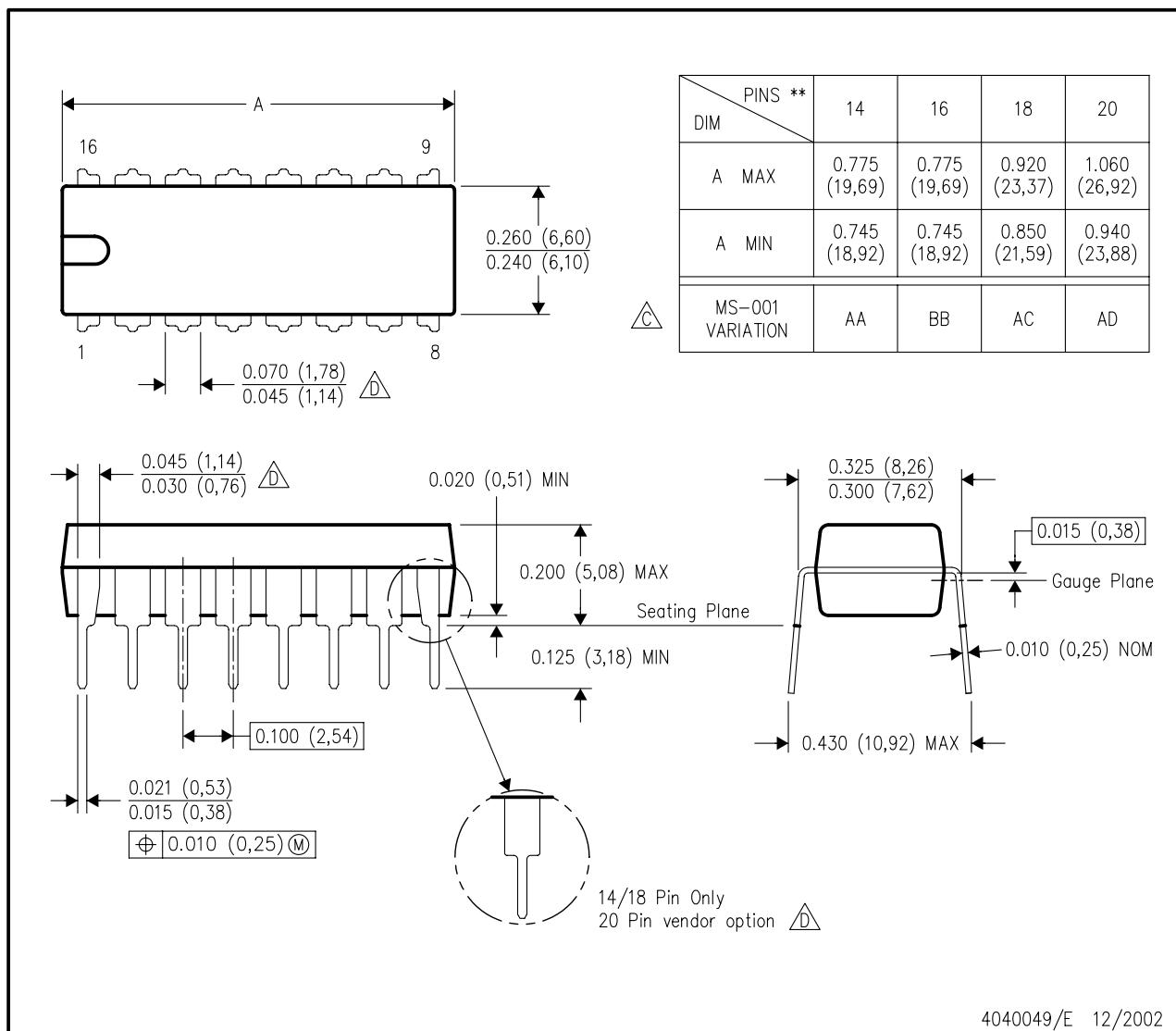
4040140/D 01/11

MECHANICAL DATA

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



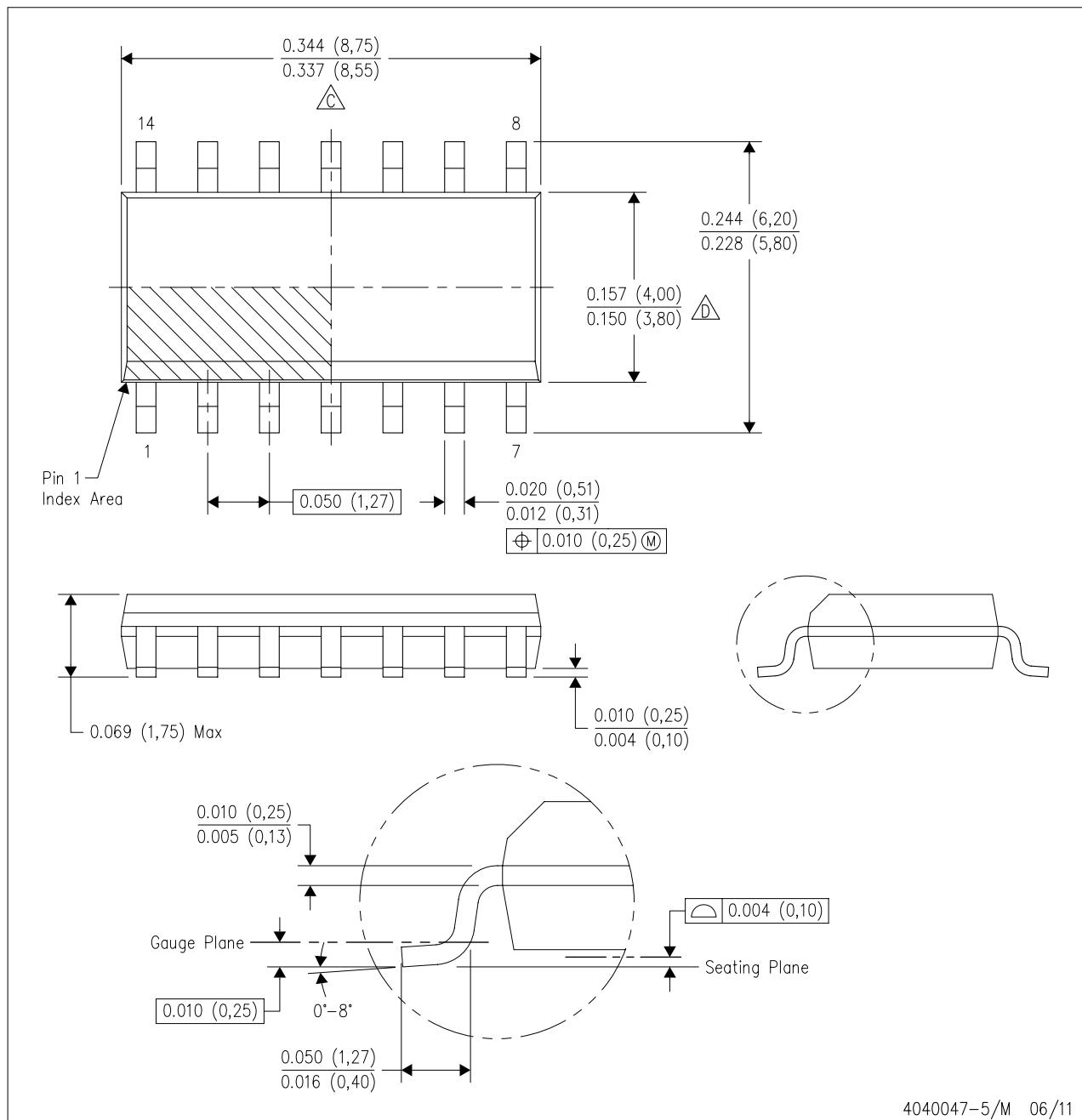
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

Symbol A: Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
Symbol D: The 20 pin end lead shoulder width is a vendor option, either half or full width.

MECHANICAL DATA

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.

C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0.15) each side.

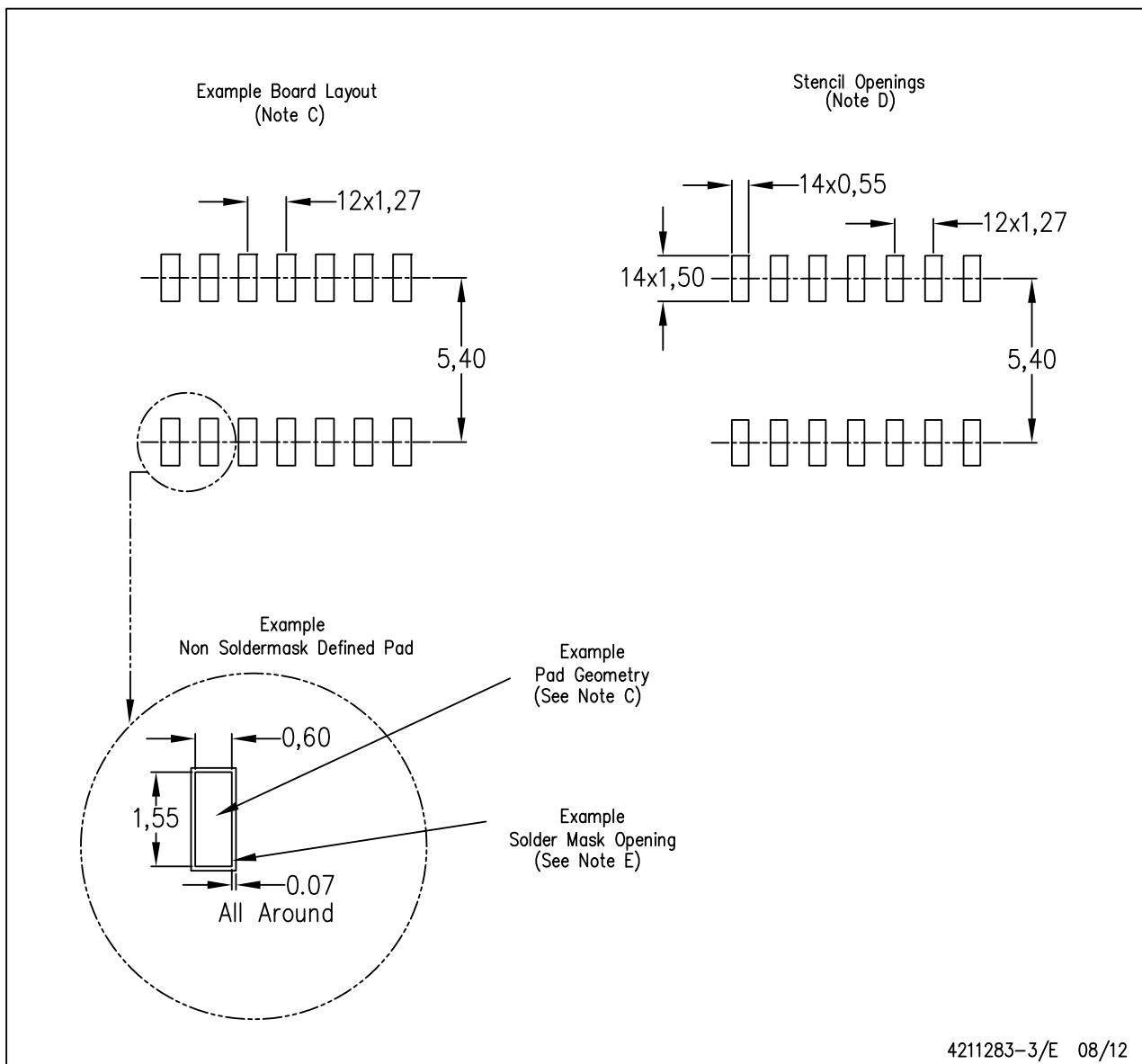
D Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0.43) each side.

E Reference JEDEC MS-012 variation AB.

LAND PATTERN DATA

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

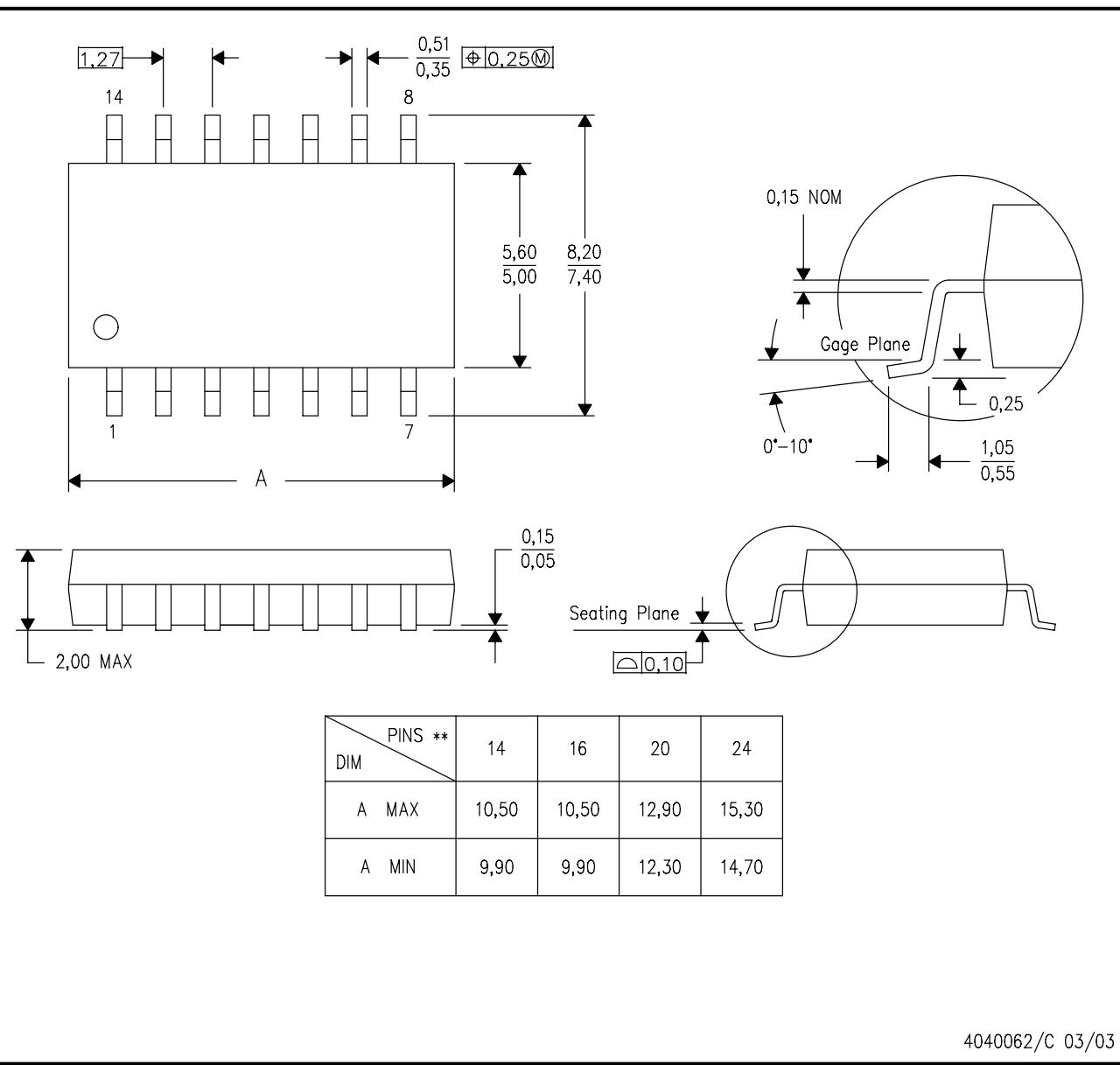
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



4040062/C 03/03

NOTES:

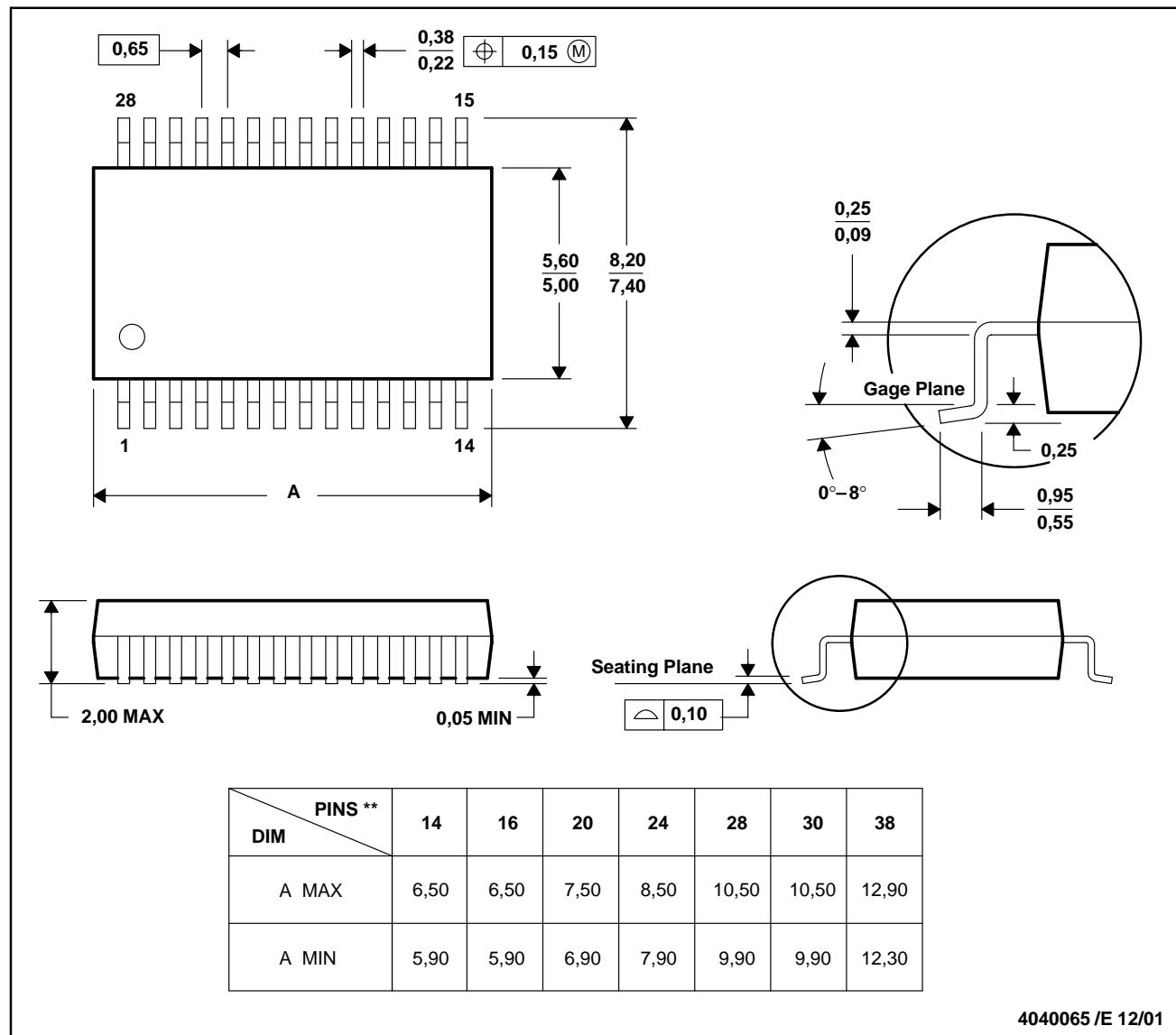
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

MSS002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)**

28 PINS SHOWN

PLASTIC SMALL-OUTLINE



4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

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